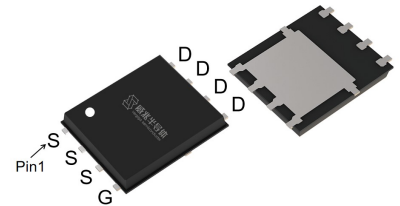


Features

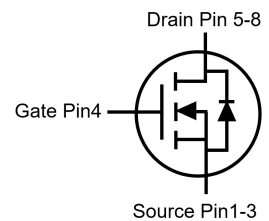
- Enhancement mode
- Very low on-resistance
- VitoMOS[®] II Technology
- Fast Switching and High efficiency
- 100% Avalanche test

| | | |
|-------------------------------|-----|----|
| V_{DS} | 30 | V |
| $R_{DS(on),TYP@ V_{GS}=10V}$ | 1.1 | mΩ |
| $R_{DS(on),TYP@ V_{GS}=4.5V}$ | 1.6 | mΩ |
| $I_D(\text{Silicon Limited})$ | 205 | A |
| $I_D(\text{Package Limited})$ | 200 | A |

PDFN5x6



| Part ID | Package Type | Marking | Packing |
|------------|--------------|----------|--------------|
| VS3603GPMT | PDFN5x6 | 3603GPMT | 3000PCS/Reel |



Maximum ratings, at $T_A = 25^\circ\text{C}$, unless otherwise specified

| Symbol | Parameter | Rating | Unit |
|----------------|-----------------------------------------------------------|---------------------------|------------------|
| $V_{(BR)DSS}$ | Drain-Source breakdown voltage | 30 | V |
| V_{GS} | Gate-Source voltage | ± 20 | V |
| I_S | Diode continuous forward current | $T_C = 25^\circ\text{C}$ | 205 A |
| I_D | Continuous drain current @ $V_{GS}=10V$ (Silicon limited) | $T_C = 25^\circ\text{C}$ | 205 A |
| I_D | Continuous drain current @ $V_{GS}=10V$ (Silicon limited) | $T_C = 100^\circ\text{C}$ | 129 A |
| I_D | Continuous drain current @ $V_{GS}=10V$ (Package limited) | $T_C = 25^\circ\text{C}$ | 200 A |
| I_{DM} | Pulse drain current tested ① | $T_C = 25^\circ\text{C}$ | 820 A |
| I_{DSM} | Continuous drain current @ $V_{GS}=10V$ | $T_A = 25^\circ\text{C}$ | 34 A |
| | | $T_A = 70^\circ\text{C}$ | 27 A |
| E_{AS} | Avalanche energy, single pulsed ② | 306 | mJ |
| P_D | Maximum power dissipation | $T_C = 25^\circ\text{C}$ | 89 W |
| | | $T_C = 100^\circ\text{C}$ | 36 W |
| P_{DSM} | Maximum power dissipation ③ | $T_A = 25^\circ\text{C}$ | 2.5 W |
| | | $T_A = 70^\circ\text{C}$ | 1.6 W |
| T_{STG}, T_J | Storage and Junction Temperature Range | -55 to 150 | $^\circ\text{C}$ |

Thermal Characteristics

| Symbol | Parameter | Typical | Max | Unit |
|-----------------|-----------------------------------------|---------|-----|---------------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case | 1.4 | 1.7 | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | 50 | 60 | $^\circ\text{C}/\text{W}$ |

Electrical Characteristics

| Symbol | Parameter | Condition | Min. | Typ. | Max. | Unit |
|--------------------------------------------------------------------------------------------|--------------------------------------------------------|----------------------------------------------------------------------------------------------|------|------|-------|------|
| Static Electrical Characteristics @ T_J=25°C (unless otherwise stated) | | | | | | |
| V(BR)DSS | Drain-Source Breakdown Voltage | V _{GS} =0V, I _D =250μA | 30 | -- | -- | V |
| I _{DSS} | Zero Gate Voltage Drain Current(T _J =25°C) | V _{DS} =30V, V _{GS} =0V | -- | -- | 1 | μA |
| | Zero Gate Voltage Drain Current(T _J =125°C) | V _{DS} =30V, V _{GS} =0V | -- | -- | 100 | μA |
| I _{GSS} | Gate-Body Leakage Current | V _{GS} =±20V, V _{DS} =0V | -- | -- | ±100 | nA |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =250μA | 1.1 | 1.6 | 2.2 | V |
| R _{DS(on)} | Drain-Source On-State Resistance ④ | V _{GS} =10V, I _D =30A | -- | 1.1 | 1.4 | mΩ |
| | | (T _J =100°C) | -- | 1.2 | -- | mΩ |
| R _{DS(on)} | Drain-Source On-State Resistance ④ | V _{GS} =4.5V, I _D =20A | -- | 1.6 | 2.1 | mΩ |
| Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated) | | | | | | |
| C _{iss} | Input Capacitance | V _{DS} =15V, V _{GS} =0V, f=1MHz | 3035 | 6070 | 10620 | pF |
| C _{oss} | Output Capacitance | | 1480 | 2955 | 5170 | pF |
| C _{rss} | Reverse Transfer Capacitance | | 220 | 440 | 775 | pF |
| R _g | Gate Resistance | f=1MHz | 0.5 | 3.4 | 5 | Ω |
| Q _{g(10V)} | Total Gate Charge | V _{DS} =15V, I _D =30A, V _{GS} =10V | -- | 102 | 179 | nC |
| Q _{g(4.5V)} | Total Gate Charge | | -- | 51 | 89 | nC |
| Q _{gs} | Gate-Source Charge | | -- | 16 | 28 | nC |
| Q _{gd} | Gate-Drain Charge | | -- | 20 | 35 | nC |
| Switching Characteristics | | | | | | |
| T _{d(on)} | Turn-on Delay Time | V _{DD} =15V, I _D =30A, R _G =3Ω, V _{GS} =10V | -- | 9.6 | -- | ns |
| T _r | Turn-on Rise Time | | -- | 83 | -- | ns |
| T _{d(off)} | Turn-Off Delay Time | | -- | 109 | -- | ns |
| T _f | Turn-Off Fall Time | | -- | 74 | -- | ns |
| Source- Drain Diode Characteristics@ T_J = 25°C (unless otherwise stated) | | | | | | |
| V _{SD} | Forward on voltage | I _{SD} =30A, V _{GS} =0V | -- | 0.8 | 1.2 | V |
| T _{rr} | Reverse Recovery Time | I _{sd} =30A, V _{GS} =0V di/dt=100A/μs | -- | 81 | 162 | ns |
| Q _{rr} | Reverse Recovery Charge | | -- | 87 | 174 | nC |

NOTE: ① Single pulse; pulse width ≤ 100μs.

② Limited by T_{Jmax}, starting T_J = 25°C, L = 0.5mH, R_G = 25Ω, I_{AS} = 35A, V_{GS} = 10V. Part not recommended for use above this value

③ The power dissipation P_{DSM} is based on R_{θJA} and the maximum allowed junction temperature of 150°C.

④ Pulse width ≤ 380μs; duty cycle ≤ 2%.

Typical Characteristics

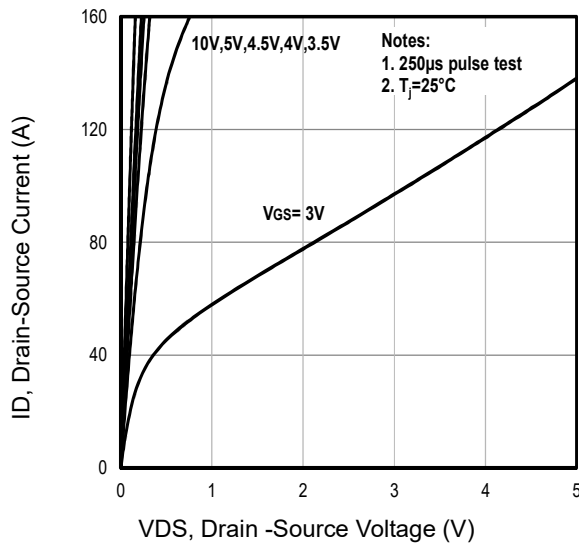


Fig1. Typical Output Characteristics

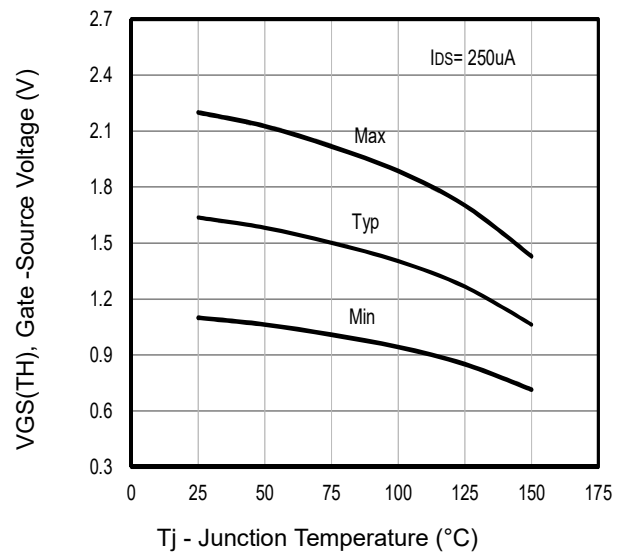


Fig2. Typical VGS(TH) Gate-Source Voltage Vs. Tj

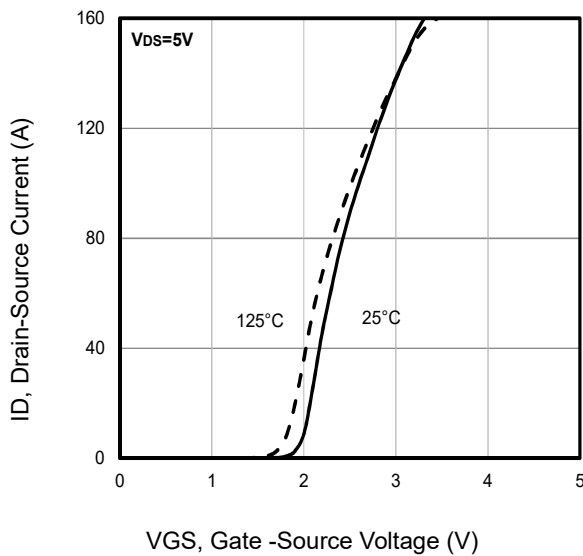


Fig3. Typical Transfer Characteristics

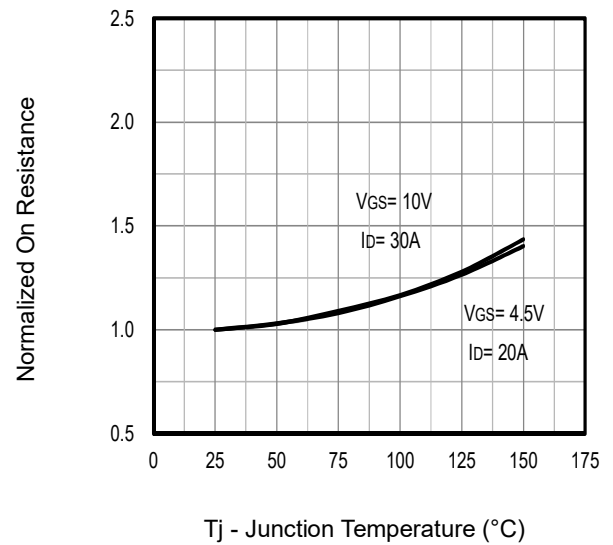


Fig4. Typical Normalized On-Resistance Vs. Tj

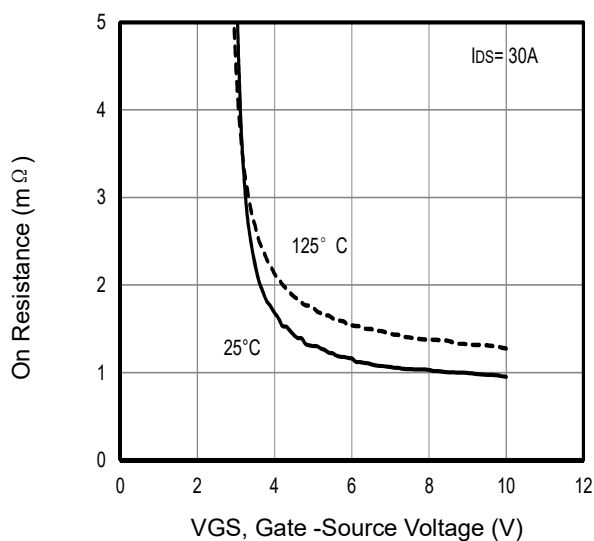


Fig5. Typical On Resistance Vs Gate-Source Voltage

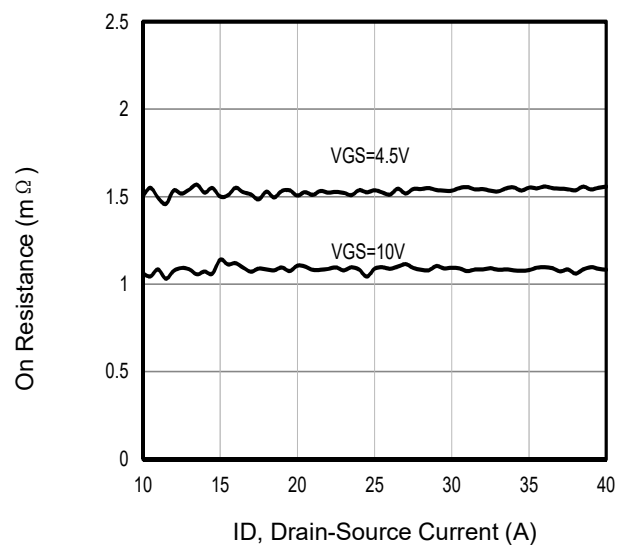


Fig6. Typical On Resistance Vs Drain Current and Gate Voltage

Typical Characteristics

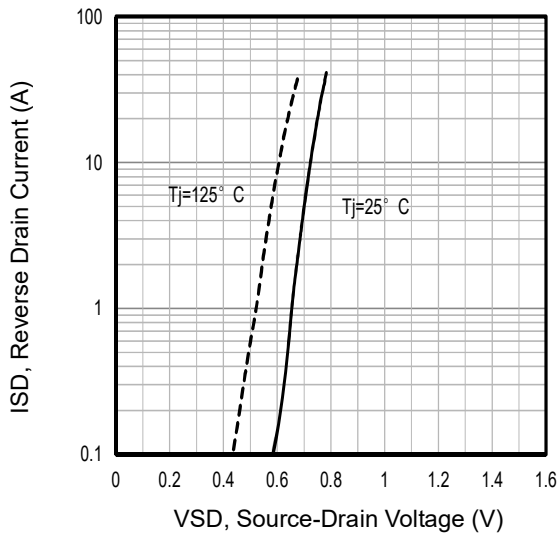


Fig7. Typical Source-Drain Diode Forward Voltage

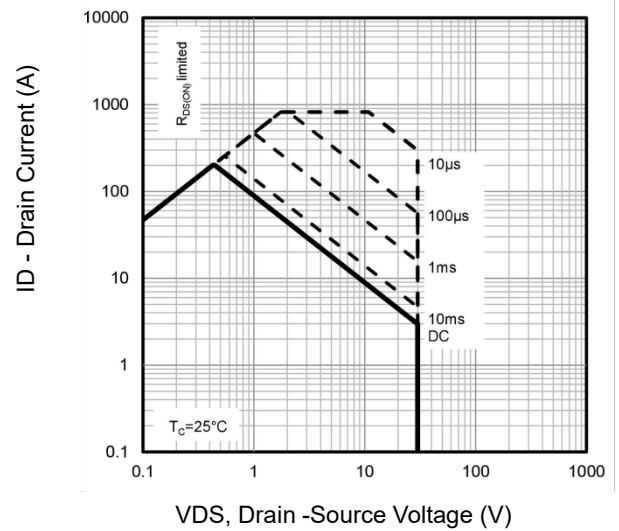


Fig8. Maximum Safe Operating Area

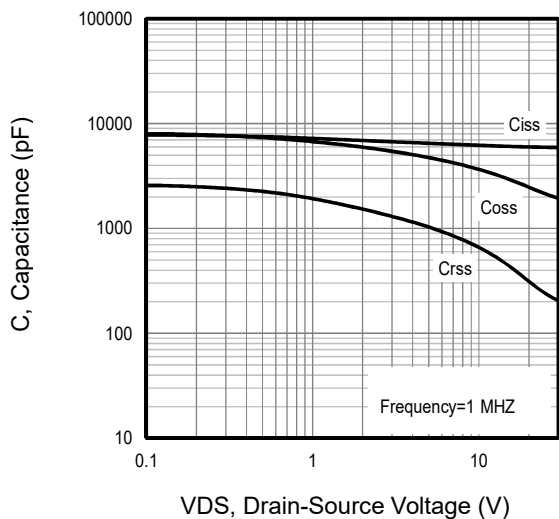


Fig9. Typical Capacitance Vs. Drain-Source Voltage

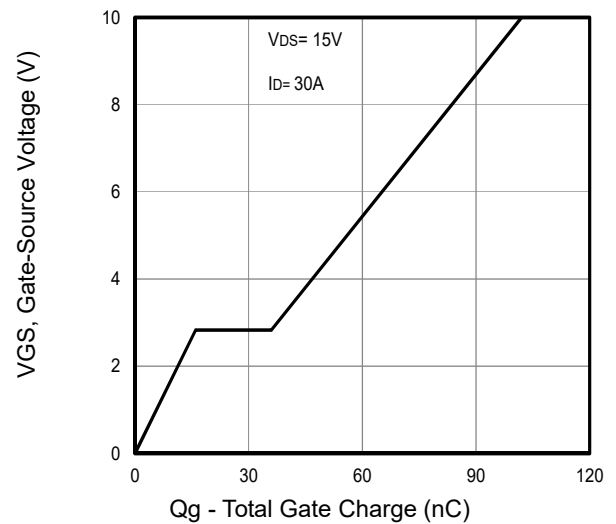


Fig10. Typical Gate Charge Vs. Gate-Source Voltage

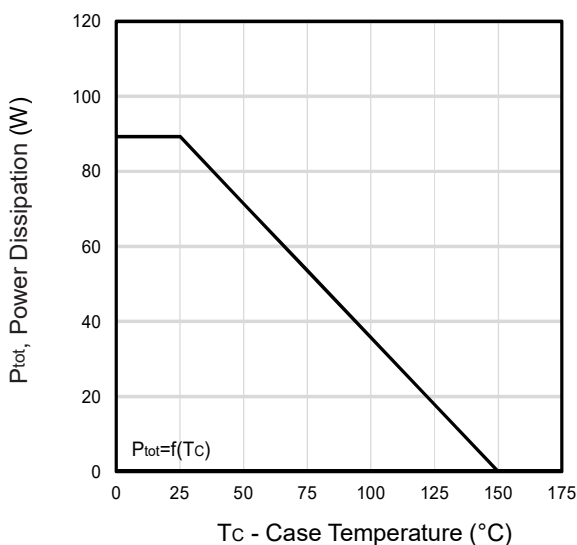


Fig11. Power Dissipation Vs. Case Temperature

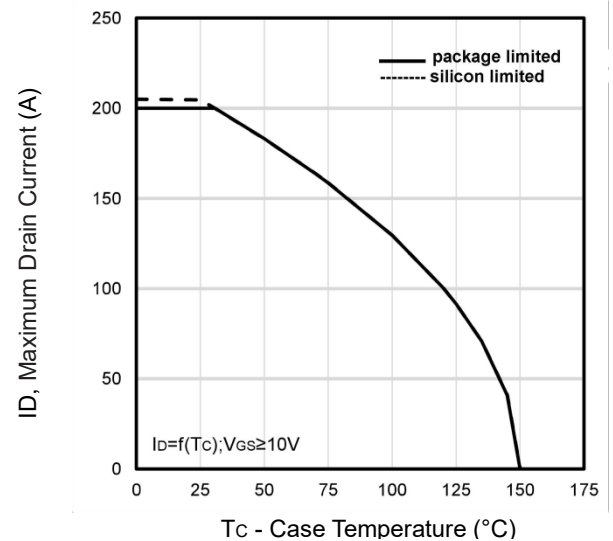


Fig12. Maximum Drain Current Vs. Case Temperature

Typical Characteristics

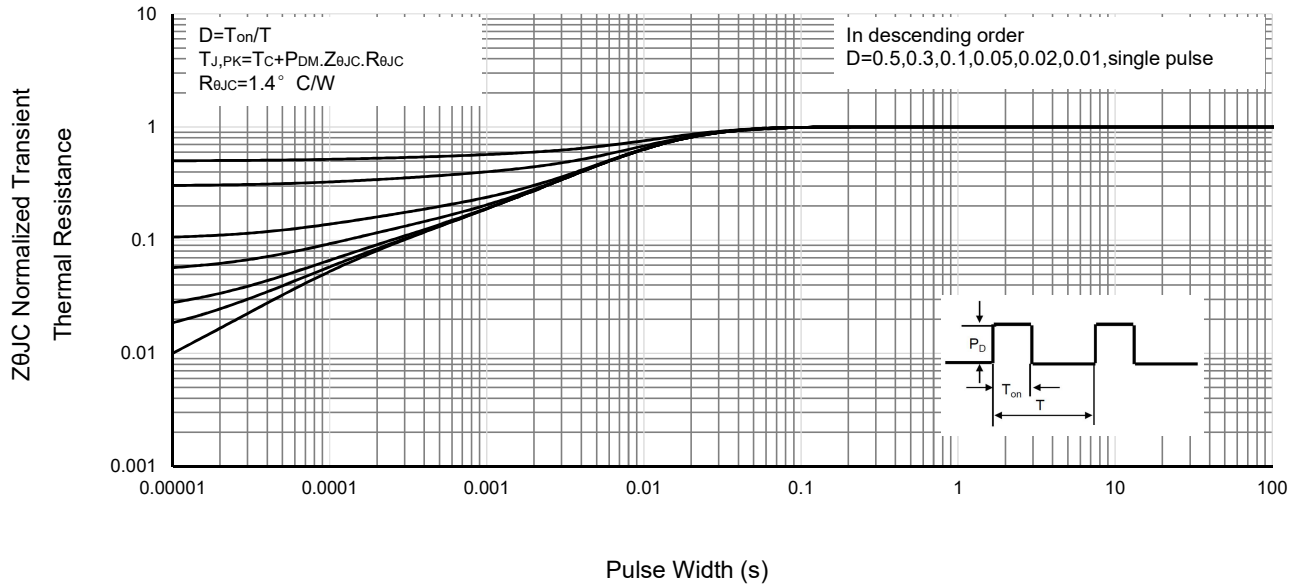


Fig13 . Normalized Maximum Transient Thermal Impedance

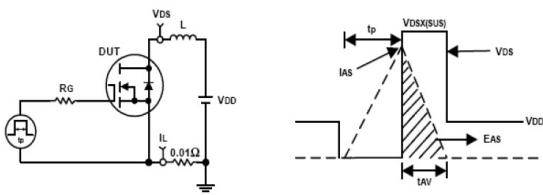


Fig14. Unclamped Inductive Test Circuit and waveforms

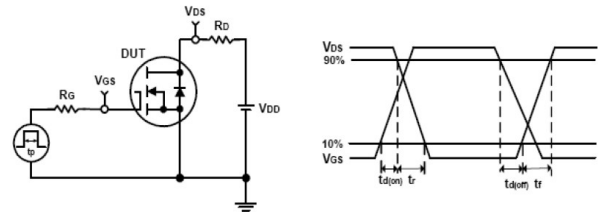
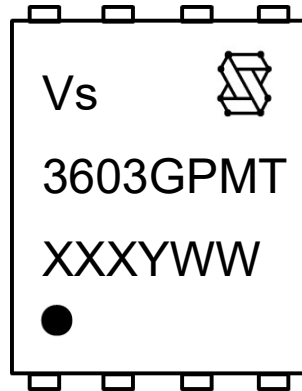


Fig15. Switching Time Test Circuit and waveforms

Marking Information



1st line: Vergiga Code (Vs) , Vergiga Logo

2nd line: Part Number (3603GPMT)

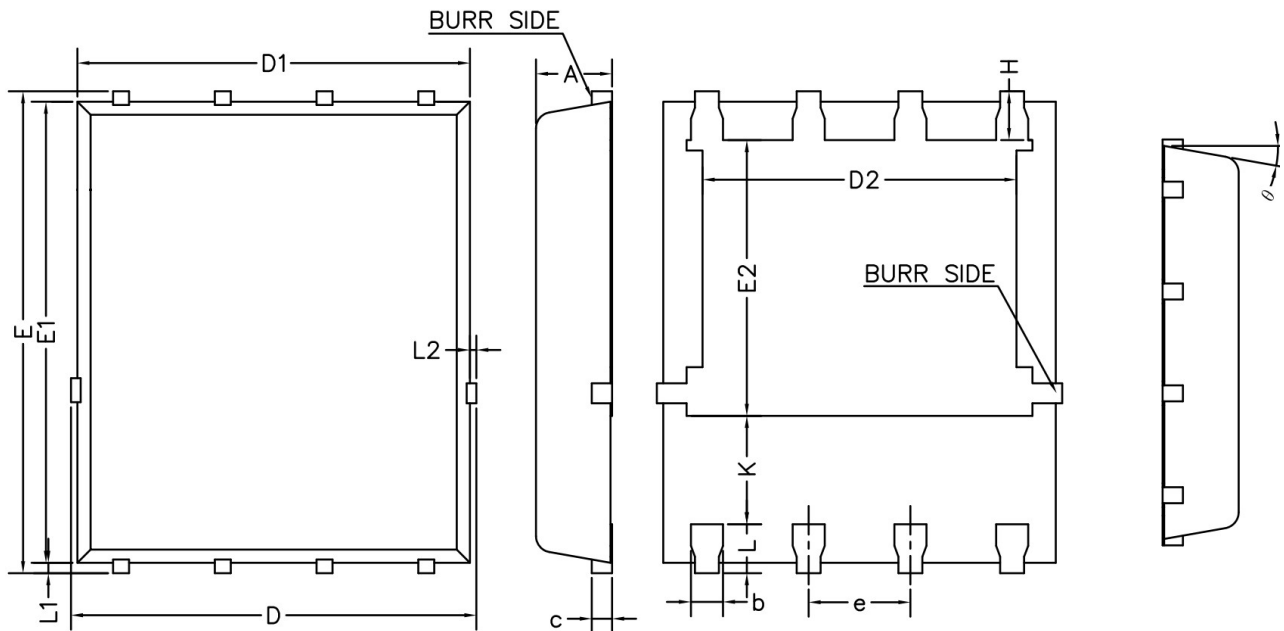
3rd line: Date code (XXXYWW)

XXX: Wafer Lot Number Code, code changed with Lot Number

Y: Year Code , refer to table below

WW: Week Code (01 to 53)

| Code | C | D | E | F | G | H | J | K | L | M | N | P | Q | R | S | T |
|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| Year | 2015 | 2016 | 2017 | 2018 | 2019 | 2020 | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 | 2030 |

PDFN5x6 Package Outline Data


| Symbol | DIMENSIONS (unit : mm) | | |
|-----------|--------------------------|------|------|
| | Min | Typ | Max |
| A | 0.90 | 1.00 | 1.10 |
| b | 0.25 | 0.40 | 0.51 |
| c | 0.20 | 0.25 | 0.34 |
| D | -- | -- | 5.20 |
| D1 | 4.80 | 4.90 | 5.10 |
| D2 | 3.61 | -- | 4.20 |
| e | 1.27 BSC | | |
| E | 5.90 | 6.00 | 6.20 |
| E1 | 5.70 | 5.80 | 5.95 |
| E2 | 3.34 | -- | 3.85 |
| H | 0.41 | 0.61 | 0.75 |
| K | 1.10 | -- | -- |
| L | 0.41 | 0.61 | 0.75 |
| L1 | 0.05 | 0.15 | 0.25 |
| L2 | -- | -- | 0.12 |
| θ | 0° | -- | 13° |

Notes:

- 1.Refer to JEDEC MO-240 variation AA.
- 2.Dimensions "D1" and "E1" do NOT include mold flash protrusions or gate burrs.
- 3.Dimensions "D1" and "E1" include interterminal flash or protrusion. Interterminal flash or protrusion shall not exceed 0.25mm per side.

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[TK31J60W5,S1VQ\(O](#) [2SK2614\(TE16L1,Q\)](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#) [FCAB21350L1](#) [P85W28HP2F-7071](#) [DMN1053UCP4-7](#)
[NTE2384](#) [NTE2969](#) [NTE6400A](#) [DMN2080UCB4-7](#) [DMN61D9UWQ-13](#) [US6M2GTR](#) [DMN31D5UDJ-7](#) [SSM6P54TU,LF](#) [DMP22D4UFO-](#)
[7B](#) [IPS60R3K4CEAKMA1](#) [DMN1006UCA6-7](#) [DMN16M9UCA6-7](#) [STF5N65M6](#) [STU5N65M6](#) [C3M0021120D](#) [DMN13M9UCA6-7](#)
[BSS340NWH6327XTSA1](#) [MCM3400A-TP](#) [DMTH10H4M6SPS-13](#) [IRF40SC240ARMA1](#) [IPS60R1K0PFD7SAKMA1](#)
[IPS60R360PFD7SAKMA1](#) [IPS60R600PFD7SAKMA1](#)